



Miniature 25 Amps • 1PDT To MIL-PRF-6106 **DC Suppressed Coils**

SPECIFICATIONS

GENERAL

Contact Arrangement1PDT (1 Form C) Weight......1.6 oz approx. Designed to meet the requirements of MIL-PRF-6106

PERFORMANCE

Contact Rating (Note 1)

(Case Grounded) Inductive15 Amps @ 115/208V 400 Hz (Case Grounded) 10 Amps @ 28 VDC (Case Grounded) (Case Grounded) Lamp5 Amps @ 28 VDC or 115/208V 400 Hz (Case Grounded)

Life50,000 operations minimum @ rated resistive load, 125°C

115/208V 400 Hz

115/208V 400 Hz

Pull In Power500 mw approx.

Operate/Release Time: DC Coil 15 ms max

Excluding bounce time at nominal coil voltage

Contact Bounce Time......1 ms max @ rated contact load, 28 VDC

Contact Voltage Drop:

Before Life......150 mv max @ 25 Amps and 6 VDC After Life175 mv max @ 25 Amps and 6 VDC

ENVIRONMENTAL

Temperature Range-70°C to +125°C 30 G's 70 - 3.000 Hz **Shock (Operating)**(Note 2)200 G's 6 ms

ELECTRICAL CHARACTERISTICS

Duty Cycle......Continuous @ 500V 25°C

Dielectric Strength:

Sea Level:

Contact to Case1.250 VRMS Coil to Case1,000 VRMS Across Open Contacts1,250 VRMS 80,000 Feet: All Points350 VRMS

MIL-PRF-6106/19 QUALIFIED

Notes

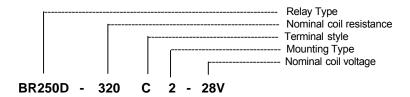
1. For other ratings consult the factory.

2. For applications requiring higher shock and vibration, consult the factory.

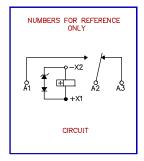


COIL DATA

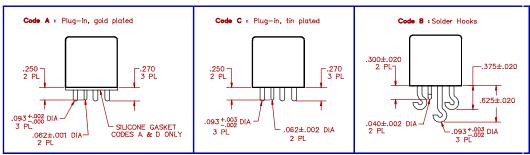
MODEL BR250D PART NUMBER	BR250D-20()()-6V	BR250D-80()()-12V	BR250D-320()()-28V	BR250D-1000()()-48V
NOMINAL COIL VOLTAGE	6 VDC	12 VDC	28 VDC	48 VDC
MAXIMUM COIL VOLTAGE	8 VDC	15 VDC	29 VDC	59 VDC
PULL IN VOLTAGE (MAX @ +125°C)	4.5 VDC	9 VDC	18 VDC	36 VDC
DROP OUT VOLTAGE (MAX)	1.8 VDC	3.5 VDC	5.1 VDC	11 VDC
MAXIMUM BACK EMF	9 VDC	18 VDC	42 VDC	72 VDC
COIL RESISTANCE ± 10% @ 25°C	20 OHMS	80 OHMS	320 OHMS	1000 OHMS



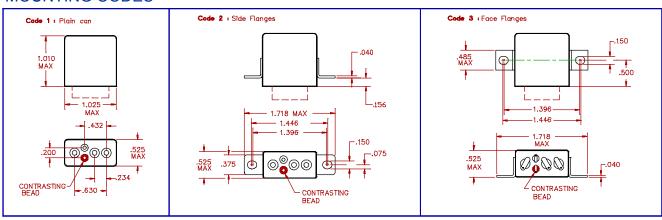
SCHEMATIC TERMINAL VIEW



TERMINAL STYLES



MOUNTING CODES



GENERAL NOTES

- Unless otherwise specified, all tests made at nominal coil voltages, @ 25°C.
- For special coil variations, switching configurations, terminals styles and mounting types, consult the factory.
- Unless otherwise specified, tolerances on decimal dimensions are ± .010".
- Specifications contained herein are subject to change without notice.



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